

## General Purpose CMOS Logic IC

# Automotive Single Schmitt Trigger Buffer

## BD7LS17G-C

### General Description

The BD7LS17G-C is a Single Schmitt Trigger Buffer and qualified for automotive applications. This is designed for 1.65 V to 5.5 V power supply voltage operation.

When it is power down, the Output Tolerant circuit protects the output circuit from the back flow current through the connected system.

### Features

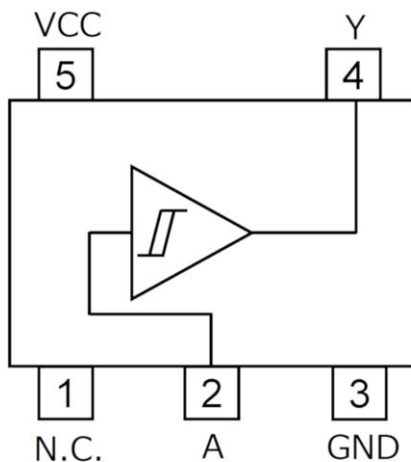
- AEC-Q100 Qualified<sup>(Note 1)</sup>
  - 4000 V Human-body Model
  - 1000 V Charged-device Model
- Low Power Consumption
- 5.5 V Tolerant Inputs
- Output Tolerant Supports Partial Power Down Mode Operation
- Package SSOP5 is Similar to SOT-23-5(JEDEC)

(Note 1) Grade 1

### Applications

- Automotive

### Pin Configuration and Logic Diagram (Top View)



### Key Specifications

- Supply Voltage Range: 1.65 V to 5.5 V
- Low Current Consumption ( $I_{CC}$ ): 10  $\mu$ A (Max)
- Operating Temperature Range: -40 °C to +125 °C
- Max Propagation Delay Time: 12.0 ns (@3.0 V)
- Output Drive Capability:  $\pm 24$  mA (@3.0 V)

### Package SSOP5

**W(Typ) x D (Typ) x H (Max)**  
2.9 mm x 2.8 mm x 1.25 mm



### Pin Descriptions

| Pin No. | Pin Name | Function      | I/O |
|---------|----------|---------------|-----|
| 1       | N.C.     | No connection | -   |
| 2       | A        | Input         | I   |
| 3       | GND      | Ground        | -   |
| 4       | Y        | Output        | O   |
| 5       | VCC      | Power supply  | -   |

### Truth Table

| Input<br>A | Output<br>Y |
|------------|-------------|
| L          | L           |
| H          | H           |

## Absolute Maximum Ratings (Ta = 25 °C)

| Parameter                                 | Symbol            | Rating       | Unit |
|-------------------------------------------|-------------------|--------------|------|
| Supply Voltage Range                      | V <sub>CC</sub>   | -0.5 to +6.5 | V    |
| Input Voltage Range                       | V <sub>IN</sub>   | -0.5 to +6.5 | V    |
| Input Diode Current (V <sub>IN</sub> < 0) | I <sub>IK</sub>   | -50          | mA   |
| Output Diode Current (V <sub>O</sub> < 0) | I <sub>OK</sub>   | -50          | mA   |
| Output Current                            | I <sub>O</sub>    | ±50          | mA   |
| VCC-GND Current                           | I <sub>CC</sub>   | ±50          | mA   |
| Maximum Junction Temperature              | T <sub>jmax</sub> | +150         | °C   |
| Storage Temperature Range                 | T <sub>stg</sub>  | -55 to +150  | °C   |

**Caution 1:** Operating the IC over the absolute maximum ratings may damage the IC. The damage can either be a short circuit between pins or an open circuit between pins and the internal circuitry. Therefore, it is important to consider circuit protection measures, such as adding a fuse, in case the IC is operated over the absolute maximum ratings.

**Caution 2:** Should by any chance the maximum junction temperature rating be exceeded the rise in temperature of the chip may result in deterioration of the properties of the chip. In case of exceeding this absolute maximum rating, design a PCB with thermal resistance taken into consideration by increasing board size and copper area so as not to exceed the maximum junction temperature rating.

## Thermal Resistance (Note 1)

| Parameter                                                      | Symbol          | Thermal Resistance (Typ) |                          | Unit |
|----------------------------------------------------------------|-----------------|--------------------------|--------------------------|------|
|                                                                |                 | 1s <sup>(Note 3)</sup>   | 2s2p <sup>(Note 4)</sup> |      |
| SSOP5                                                          |                 |                          |                          |      |
| Junction to Ambient                                            | θ <sub>JA</sub> | 376.5                    | 185.4                    | °C/W |
| Junction to Top Characterization Parameter <sup>(Note 2)</sup> | Ψ <sub>JT</sub> | 40                       | 30                       | °C/W |

| Layer Number of Measurement Board | Material | Board Size                    |
|-----------------------------------|----------|-------------------------------|
| Single                            | FR-4     | 114.3 mm x 76.2 mm x 1.57 mmt |

| Top                   |           |
|-----------------------|-----------|
| Copper Pattern        | Thickness |
| Footprints and Traces | 70 μm     |

| Layer Number of Measurement Board | Material | Board Size                   |
|-----------------------------------|----------|------------------------------|
| 4 Layers                          | FR-4     | 114.3 mm x 76.2 mm x 1.6 mmt |

| Top                   |           | 2 Internal Layers |           | Bottom            |           |
|-----------------------|-----------|-------------------|-----------|-------------------|-----------|
| Copper Pattern        | Thickness | Copper Pattern    | Thickness | Copper Pattern    | Thickness |
| Footprints and Traces | 70 μm     | 74.2 mm x 74.2 mm | 35 μm     | 74.2 mm x 74.2 mm | 70 μm     |

(Note 1) Based on JESD51-2A (Still-Air).

(Note 2) The thermal characterization parameter to report the difference between junction temperature and the temperature at the top center of the outside surface of the component package.

(Note 3) Using a PCB board based on JESD51-3.

(Note 4) Using a PCB board based on JESD51-7.

## Recommended Operating Conditions

| Parameter             | Symbol           | Min  | Typ | Max             | Unit | Conditions          |
|-----------------------|------------------|------|-----|-----------------|------|---------------------|
| Supply Voltage        | V <sub>CC</sub>  | 1.65 | -   | 5.5             | V    | Operating           |
|                       |                  | 1.5  | -   | 5.5             | V    | Data Retention Only |
| Input Voltage         | V <sub>IN</sub>  | 0    | -   | 5.5             | V    | -                   |
| Output Voltage        | V <sub>O</sub>   | 0    | -   | V <sub>CC</sub> | V    | -                   |
| Operating Temperature | T <sub>opr</sub> | -40  | -   | +125            | °C   | -                   |

(Note) The recommended operating conditions are the range where operation is guaranteed. If this ranges are exceeded, operation is not guaranteed even within the absolute maximum ratings. Unused inputs must be tied to either V<sub>CC</sub> or GND.

## Electrical Characteristics

(Unless otherwise specified  $V_{CC} = 1.65 \text{ V}$  to  $5.5 \text{ V}$  and  $T_a = -40 \text{ }^{\circ}\text{C}$  to  $+125 \text{ }^{\circ}\text{C}$ )

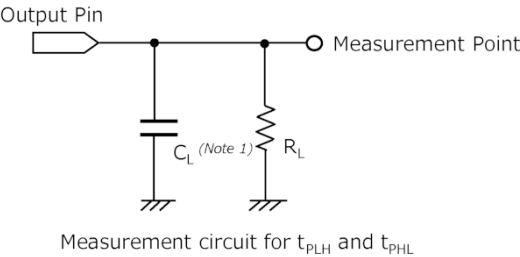
| Parameter                    | Symbol          | Min            | Typ | Max     | Unit          | Conditions      |                                                                 |
|------------------------------|-----------------|----------------|-----|---------|---------------|-----------------|-----------------------------------------------------------------|
|                              |                 |                |     |         |               | $V_{CC}$        |                                                                 |
| Positive Threshold Voltage   | $V_P$           | 0.60           | -   | 1.40    | V             | 1.65 V          | -                                                               |
|                              |                 | 0.70           | -   | 1.50    |               | 1.8 V           |                                                                 |
|                              |                 | 1.00           | -   | 1.80    |               | 2.3 V           |                                                                 |
|                              |                 | 1.30           | -   | 2.20    |               | 3.0 V           |                                                                 |
|                              |                 | 1.90           | -   | 3.10    |               | 4.5 V           |                                                                 |
|                              |                 | 2.20           | -   | 3.60    |               | 5.5 V           |                                                                 |
| Negative Threshold Voltage   | $V_N$           | 0.20           | -   | 0.80    | V             | 1.65 V          | -                                                               |
|                              |                 | 0.25           | -   | 0.90    |               | 1.8 V           |                                                                 |
|                              |                 | 0.40           | -   | 1.15    |               | 2.3 V           |                                                                 |
|                              |                 | 0.60           | -   | 1.50    |               | 3.0 V           |                                                                 |
|                              |                 | 1.00           | -   | 2.00    |               | 4.5 V           |                                                                 |
|                              |                 | 1.20           | -   | 2.40    |               | 5.5 V           |                                                                 |
| Hysteresis Voltage           | $V_H$           | 0.10           | -   | 1.00    | V             | 1.65 V          | -                                                               |
|                              |                 | 0.15           | -   | 1.00    |               | 1.8 V           |                                                                 |
|                              |                 | 0.25           | -   | 1.10    |               | 2.3 V           |                                                                 |
|                              |                 | 0.40           | -   | 1.20    |               | 3.0 V           |                                                                 |
|                              |                 | 0.60           | -   | 1.50    |               | 4.5 V           |                                                                 |
|                              |                 | 0.70           | -   | 1.70    |               | 5.5 V           |                                                                 |
| Output "H" Voltage           | $V_{OH}$        | $V_{CC} - 0.1$ | -   | -       | V             | 1.65 V to 5.5 V | $I_{OH} = -100 \mu\text{A}$                                     |
|                              |                 | 1.2            | -   | -       |               | 1.65 V          | $I_{OH} = -4 \text{ mA}$                                        |
|                              |                 | 1.8            | -   | -       |               | 2.3 V           | $I_{OH} = -8 \text{ mA}$                                        |
|                              |                 | 2.3            | -   | -       |               | 3.0 V           | $I_{OH} = -16 \text{ mA}$                                       |
|                              |                 | 2.1            | -   | -       |               | 3.0 V           | $I_{OH} = -24 \text{ mA}$                                       |
|                              |                 | 3.4            | -   | -       |               | 4.5 V           | $I_{OH} = -32 \text{ mA}$                                       |
| Output "L" Voltage           | $V_{OL}$        | -              | -   | 0.10    | V             | 1.65 V to 5.5 V | $I_{OL} = 100 \mu\text{A}$                                      |
|                              |                 | -              | -   | 0.45    |               | 1.65 V          | $I_{OL} = 4 \text{ mA}$                                         |
|                              |                 | -              | -   | 0.40    |               | 2.3 V           | $I_{OL} = 8 \text{ mA}$                                         |
|                              |                 | -              | -   | 0.60    |               | 3.0 V           | $I_{OL} = 16 \text{ mA}$                                        |
|                              |                 | -              | -   | 0.90    |               | 3.0 V           | $I_{OL} = 24 \text{ mA}$                                        |
|                              |                 | -              | -   | 1.00    |               | 4.5 V           | $I_{OL} = 32 \text{ mA}$                                        |
| Input Current                | $I_{IN}$        | -              | -   | $\pm 2$ | $\mu\text{A}$ | 0 V to 5.5 V    | $V_{IN} = 5.5 \text{ V}$ or GND                                 |
| Power Off Output Pin Current | $I_{OFF}$       | -              | -   | 10      | $\mu\text{A}$ | 0 V             | $V_{IN}$ or $V_O = 5.5 \text{ V}$                               |
| Quiescent Supply Current     | $I_{CC}$        | -              | -   | 10      | $\mu\text{A}$ | 1.65 V to 5.5 V | -                                                               |
| Supply Current Increase      | $\Delta I_{CC}$ | -              | -   | 600     | $\mu\text{A}$ | 3.0 V to 5.5 V  | Input:<br>$V_{CC} - 0.6 \text{ V}$                              |
| Input Capacitance            | $C_I$           | -              | 4   | -       | pF            | 3.3 V           | $V_{IN} = V_{CC}$ or GND<br>$T_a = 25 \text{ }^{\circ}\text{C}$ |

Switching Characteristics

(Unless otherwise specified  $V_{CC} = 1.65\text{ V to }5.5\text{ V}$  and  $T_a = -40\text{ }^{\circ}\text{C to }+125\text{ }^{\circ}\text{C}$ )

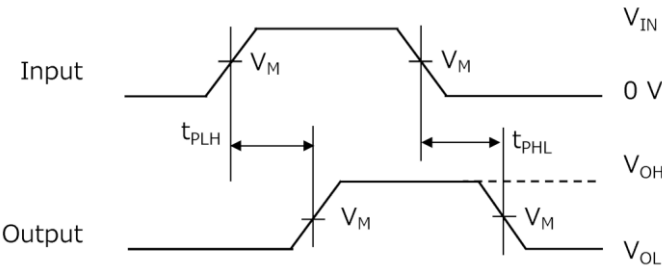
| Parameter                           | Symbol                 | FROM<br>(Input) | TO<br>(Output) | Min | Typ | Max  | Unit | Conditions       |                                                             |
|-------------------------------------|------------------------|-----------------|----------------|-----|-----|------|------|------------------|-------------------------------------------------------------|
|                                     |                        |                 |                |     |     |      |      | $V_{CC}$         |                                                             |
| Propagation<br>Delay Time           | $t_{PLH}$<br>$t_{PHL}$ | A               | Y              | 1.9 | -   | 16.0 | ns   | 1.65 V to 1.95 V | -                                                           |
|                                     |                        |                 |                | 1.0 | -   | 13.0 |      | 2.3 V to 2.7 V   | -                                                           |
|                                     |                        |                 |                | 0.9 | -   | 12.0 |      | 3.0 V to 3.6 V   | -                                                           |
|                                     |                        |                 |                | 0.6 | -   | 11.0 |      | 4.5 V to 5.5 V   | -                                                           |
| Power<br>Dissipation<br>Capacitance | $C_{PD}$               | -               | -              | -   | 29  | -    | pF   | 3.3 V            | $f = 10\text{ MHz}$ ,<br>$T_a = 25\text{ }^{\circ}\text{C}$ |
|                                     |                        | -               | -              | -   | 36  | -    | pF   | 5.0 V            | $f = 10\text{ MHz}$ ,<br>$T_a = 25\text{ }^{\circ}\text{C}$ |

Parameter Measurement Conditions



| $V_{CC}$         | $V_{IN}$ | $V_M$               | $C_L$ (Note 1) | $R_L$        | tr/tf (Inputs)       |
|------------------|----------|---------------------|----------------|--------------|----------------------|
| 1.65 V to 1.95 V | $V_{CC}$ | $0.5 \times V_{CC}$ | 30 pF          | 1k $\Omega$  | $\leq 2\text{ ns}$   |
| 2.3 V to 2.7 V   | $V_{CC}$ | $0.5 \times V_{CC}$ | 30 pF          | 500 $\Omega$ | $\leq 2\text{ ns}$   |
| 3.0 V to 3.6 V   | 3.0 V    | 1.5 V               | 50 pF          | 500 $\Omega$ | $\leq 2.5\text{ ns}$ |
| 4.5 V to 5.5 V   | $V_{CC}$ | $0.5 \times V_{CC}$ | 50 pF          | 500 $\Omega$ | $\leq 2.5\text{ ns}$ |

(Note 1)  $C_L$  includes probe and test board capacitance.



Measurement Circuit and Timing Chart

Typical Performance Curves

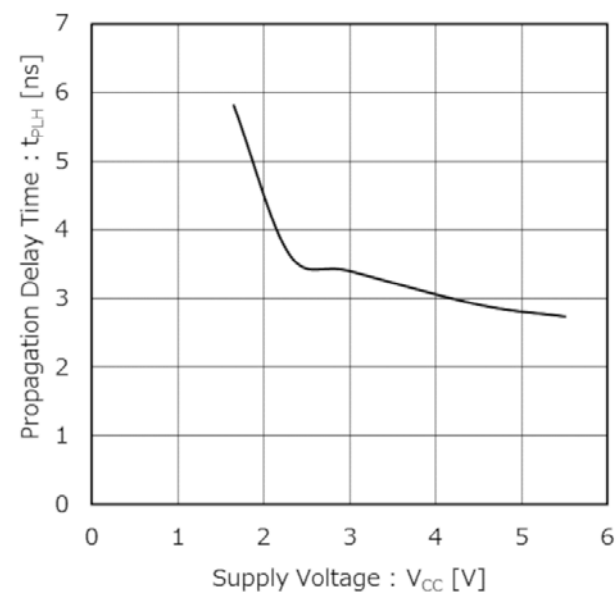


Figure 1. Propagation Delay Time:  $t_{PLH}$  vs Supply Voltage:  $V_{CC}$   
( $T_a = 25\text{ }^{\circ}\text{C}$ )

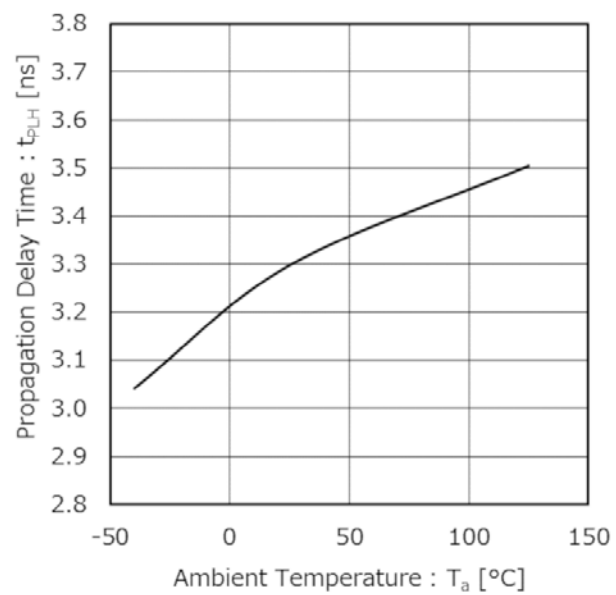


Figure 2. Propagation Delay Time:  $t_{PLH}$  vs Ambient Temperature:  $T_a$   
( $V_{CC} = 3.3\text{ V}$ )

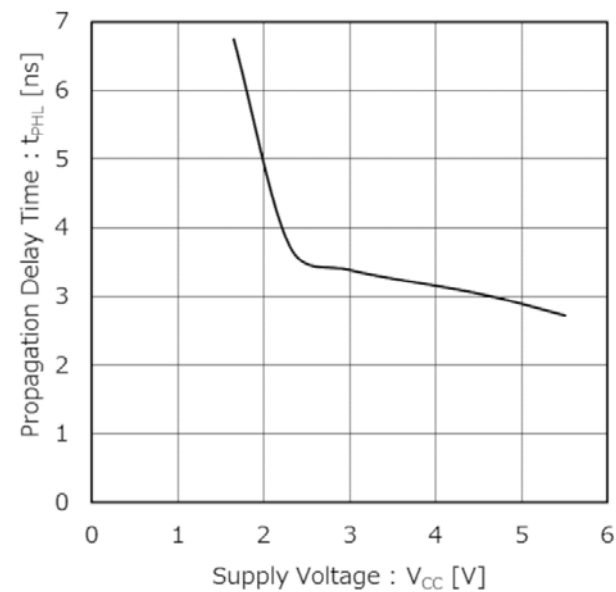


Figure 3. Propagation Delay Time:  $t_{PHL}$  vs Supply Voltage:  $V_{CC}$   
( $T_a = 25\text{ }^{\circ}\text{C}$ )

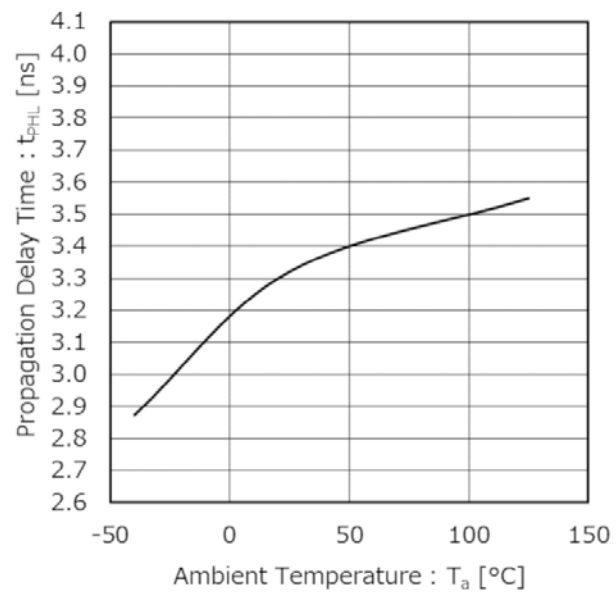


Figure 4. Propagation Delay Time:  $t_{PHL}$  vs Ambient Temperature:  $T_a$   
( $V_{CC} = 3.3\text{ V}$ )

## Operational Notes

### 1. Reverse Connection of Power Supply

Connecting the power supply in reverse polarity can damage the IC. Take precautions against reverse polarity when connecting the power supply, such as mounting an external diode between the power supply and the IC's power supply pins.

### 2. Power Supply Lines

Design the PCB layout pattern to provide low impedance supply lines. Furthermore, connect a capacitor to ground at all power supply pins. Consider the effect of temperature and aging on the capacitance value when using electrolytic capacitors.

### 3. Ground Voltage

Ensure that no pins are at a voltage below that of the ground pin at any time, even during transient condition.

### 4. Ground Wiring Pattern

When using both small-signal and large-current ground traces, the two ground traces should be routed separately but connected to a single ground at the reference point of the application board to avoid fluctuations in the small-signal ground caused by large currents. Also ensure that the ground traces of external components do not cause variations on the ground voltage. The ground lines must be as short and thick as possible to reduce line impedance.

### 5. Recommended Operating Conditions

The function and operation of the IC are guaranteed within the range specified by the recommended operating conditions. The characteristic values are guaranteed only under the conditions of each item specified by the electrical characteristics.

### 6. Inrush Current

When power is first supplied to the IC, it is possible that the internal logic may be unstable and inrush current may flow instantaneously due to the internal powering sequence and delays, especially if the IC has more than one power supply. Therefore, give special consideration to power coupling capacitance, power wiring, width of ground wiring, and routing of connections.

### 7. Operation Under Strong Electromagnetic Field

Operating the IC in the presence of a strong electromagnetic field may cause the IC to malfunction.

### 8. Testing on Application Boards

When testing the IC on an application board, connecting a capacitor directly to a low-impedance output pin may subject the IC to stress. Always discharge capacitors completely after each process or step. The IC's power supply should always be turned off completely before connecting or removing it from the test setup during the inspection process. To prevent damage from static discharge, ground the IC during assembly and use similar precautions during transport and storage.

### 9. Inter-pin Short and Mounting Errors

Ensure that the direction and position are correct when mounting the IC on the PCB. Incorrect mounting may result in damaging the IC. Avoid nearby pins being shorted to each other especially to ground, power supply and output pin. Inter-pin shorts could be due to many reasons such as metal particles, water droplets (in very humid environment) and unintentional solder bridge deposited in between pins during assembly to name a few.

### 10. Unused Input Pins

Input pins of an IC are often connected to the gate of a MOS transistor. The gate has extremely high impedance and extremely low capacitance. If left unconnected, the electric field from the outside can easily charge it. The small charge acquired in this way is enough to produce a significant effect on the conduction through the transistor and cause unexpected operation of the IC. So unless otherwise specified, unused input pins should be connected to the power supply or ground line.

## Operational Notes – continued

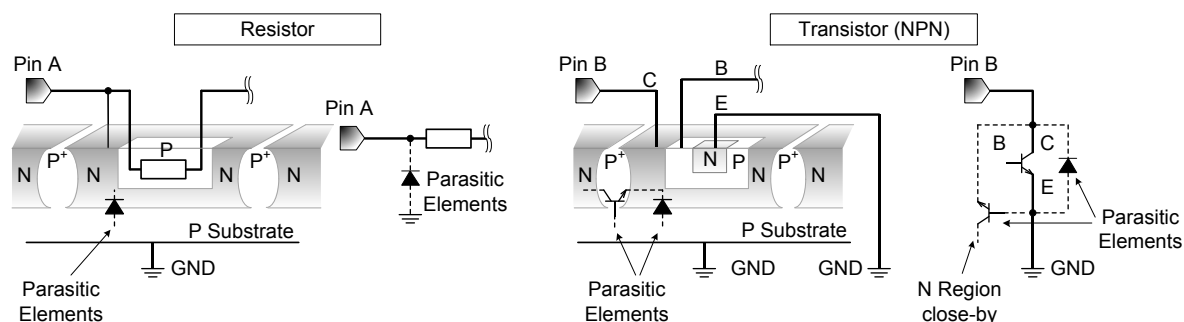
### 11. Regarding the Input Pin of the IC

This monolithic IC contains P+ isolation and P substrate layers between adjacent elements in order to keep them isolated. P-N junctions are formed at the intersection of the P layers with the N layers of other elements, creating a parasitic diode or transistor. For example (refer to figure below):

When  $GND > Pin\ A$  and  $GND > Pin\ B$ , the P-N junction operates as a parasitic diode.

When  $GND > Pin\ B$ , the P-N junction operates as a parasitic transistor.

Parasitic diodes inevitably occur in the structure of the IC. The operation of parasitic diodes can result in mutual interference among circuits, operational faults, or physical damage. Therefore, conditions that cause these



diodes to operate, such as applying a voltage lower than the GND voltage to an input pin (and thus to the P substrate) should be avoided.

Example of Monolithic IC Structure

### 12. Ceramic Capacitor

When using a ceramic capacitor, determine a capacitance value considering the change of capacitance with temperature and the decrease in nominal capacitance due to DC bias and others.

## Ordering Information

B D 7 L S 1 7 G

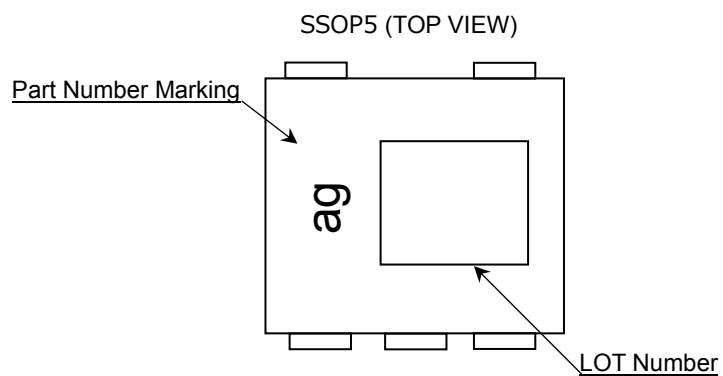
Package  
G: SSOP5

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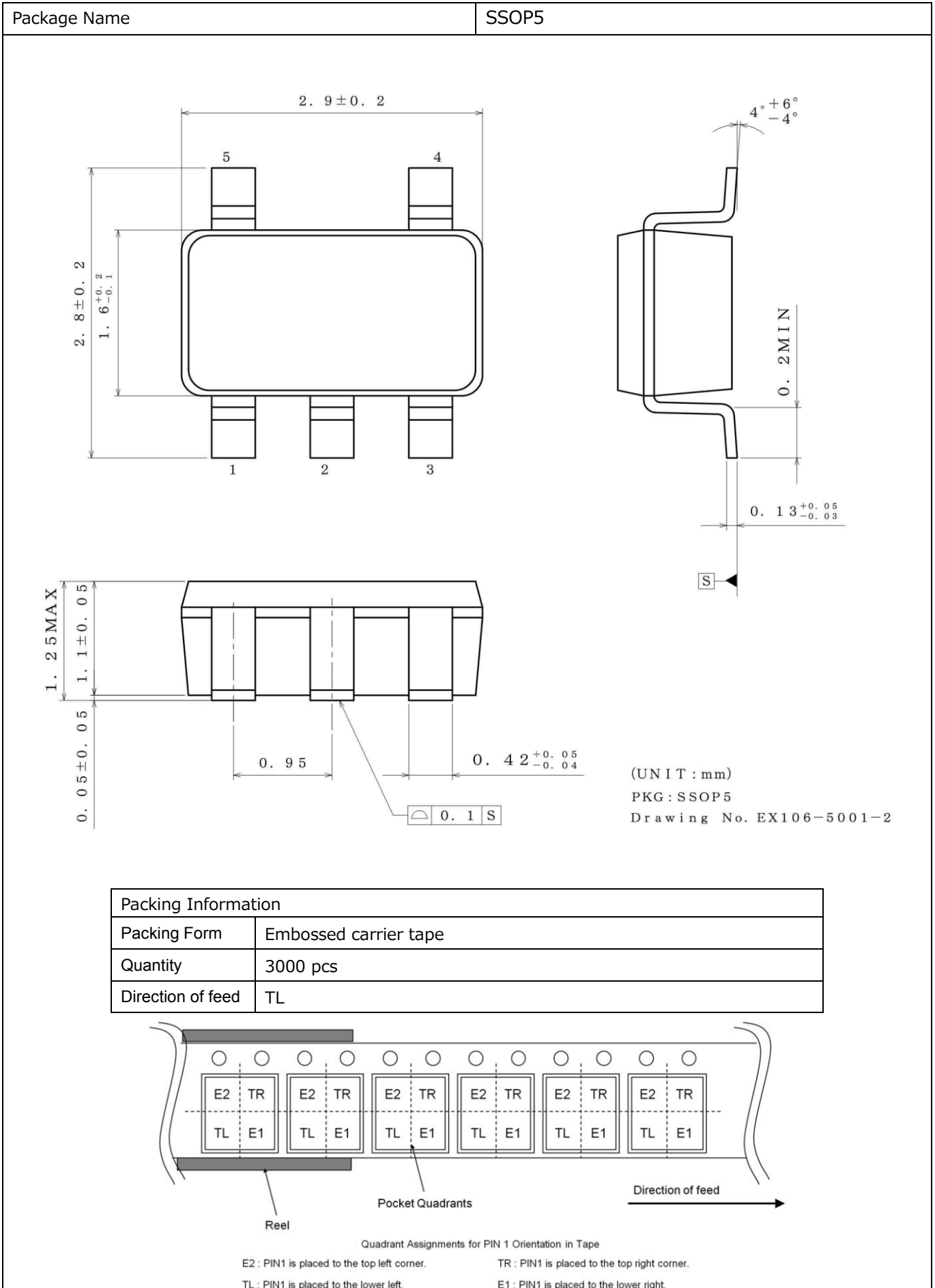
C T L

Product Rank  
C: for Automotive  
Packaging and forming specification  
TL: Embossed tape and reel

## Marking Diagram



## Physical Dimension and Packing Information



**Revision History**

| Date        | Revision | Changes     |
|-------------|----------|-------------|
| 21.Apr.2020 | 001      | New Release |

# Notice

## Precaution on using ROHM Products

1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment <sup>(Note 1)</sup>, aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

| JAPAN     | USA       | EU         | CHINA     |
|-----------|-----------|------------|-----------|
| CLASS III | CLASS III | CLASS II b | CLASS III |
| CLASS IV  |           | CLASS III  |           |

2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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  - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
3. Our Products are not designed under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
  - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
4. The Products are not subject to radiation-proof design.
5. Please verify and confirm characteristics of the final or mounted products in using the Products.
6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
8. Confirm that operation temperature is within the specified range described in the product specification.
9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

## Precaution for Mounting / Circuit board design

1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

## Precautions Regarding Application Examples and External Circuits

1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

## Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of ionizer, friction prevention and temperature / humidity control).

## Precaution for Storage / Transportation

1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

## Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

## Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

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